TOSHIBA Diode Silicon Epitaxial Planar Type

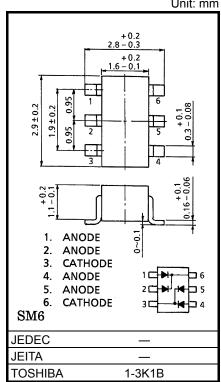
HN1D02F

Ultra-High-Speed Switching Applications

- The HN1D02F is composed of two (2) cathode common units.
- Low forward voltage $: V_{F(3)} = 0.90 V (typ.)$
- Fast reverse recovery time: t_{rr} = 1.6 ns (typ.)
- Small total capacitance $: C_T = 0.9 \text{ pF} (typ.)$

Absolute Maximum Ratings (Ta = 25°C)

| Characteristic | Symbol | Rating | Unit | |
|--------------------------------|------------------|---------|------|--|
| Maximum (peak) reverse voltage | V _{RM} | 85 | V | |
| Reverse voltage | V _R | 80 | V | |
| Maximum (peak) forward current | I _{FM} | 300 (*) | mA | |
| Average forward current | Ι _Ο | 100 (*) | mA | |
| Surge current (10 ms) | I _{FSM} | 2 (*) | А | |
| Power dissipation | Р | 300 | mW | |
| Junction temperature | Tj | 125 | °C | |
| Storage temperature | T _{stg} | -55~125 | °C | |



Weight: 0.015 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in

temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(*) These are the Absolute Maximum Ratings for a single diode (Q1 or Q2 or Q3 or Q4). If Unit 1 and Unit 2 are used independently or simultaneously, the Absolute Maximum Ratings per diode are 75% of those of a single diode.

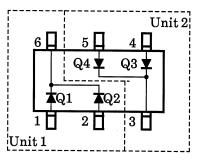
Electrical Characteristics (Q1, Q2, Q3, Q4 Common, Ta = 25°C)

| Characteristic | Symbol | Test Circuit | Test Condition | Min | Тур. | Max | Unit | |
|-----------------------|--------------------|-----------------|--------------------------------|-----|------|------|------|--|
| Forward voltage | V _{F (1)} | _ | I _F = 1 mA | | 0.60 | | V | |
| | V _{F (2)} | _ | I _F = 10 mA | | 0.72 | | | |
| | V _{F (3)} | _ | I _F = 100 mA | _ | 0.90 | 1.20 | | |
| Reverse current | I _{R (1)} | _ | V _R = 30 V | _ | _ | 0.1 | | |
| | I _{R (2)} | _ | V _R = 80 V | _ | _ | 0.5 | μA | |
| Total capacitance | CT | _ | V _R = 0, f = 1 MHz | _ | 0.9 | 3.0 | pF | |
| Reverse recovery time | trr | _ | I _F =10 mA (Fig. 1) | _ | 1.6 | 4.0 | ns | |

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Pin Assignment (Top View)

Marking



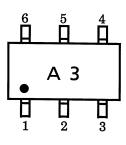
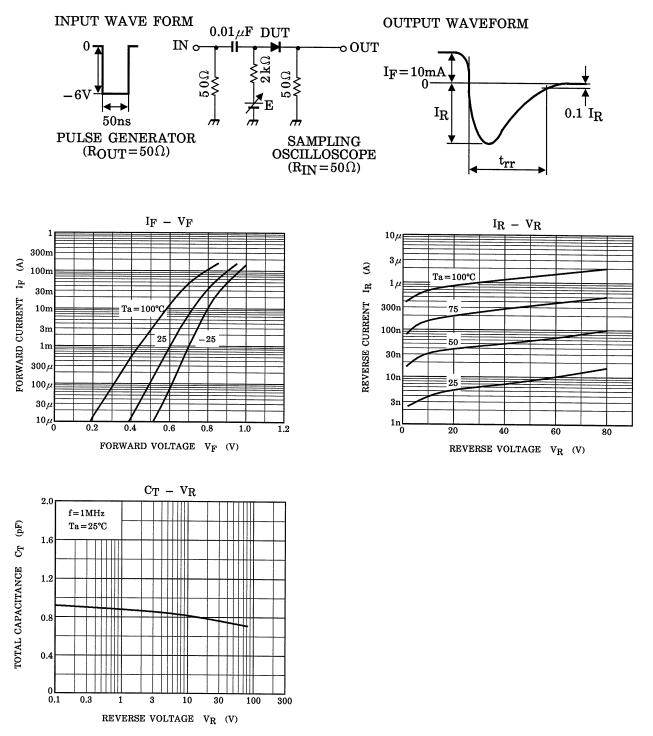


Fig. 1 Reverse Recovery Time (t_{rr}) Test Circuit



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